Silicon PNP Epitaxial

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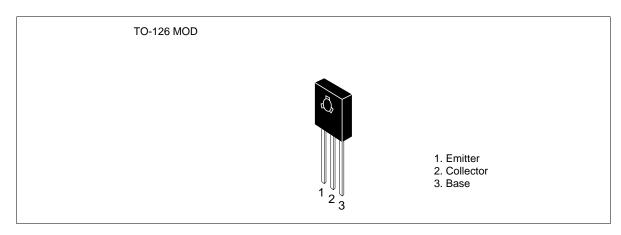
Application

High frequency amplifier

Features

- Excellent high frequency characteristics $f_T = 300 \text{ MHz typ}$
- High voltage and low output capacitance
 V_{CEO} = -200 V, Cob = 5.0 pF typ
- Suitable for wide band video amplifier

Outline





Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit	
Collector to base voltage	V _{CBO}	-200	V	
Collector to emitter voltage	V _{CEO}	-200	V	
Emitter to base voltage	V _{EBO}	-5	V	
Collector current	Ι _c	-0.2	А	
Collector peak current	I _{C(peak)}	-0.5	А	
Collector power dissipation	Pc	1.25	W	
	Pc*1	10		
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note: 1. Value at $T_c = 25^{\circ}C$.

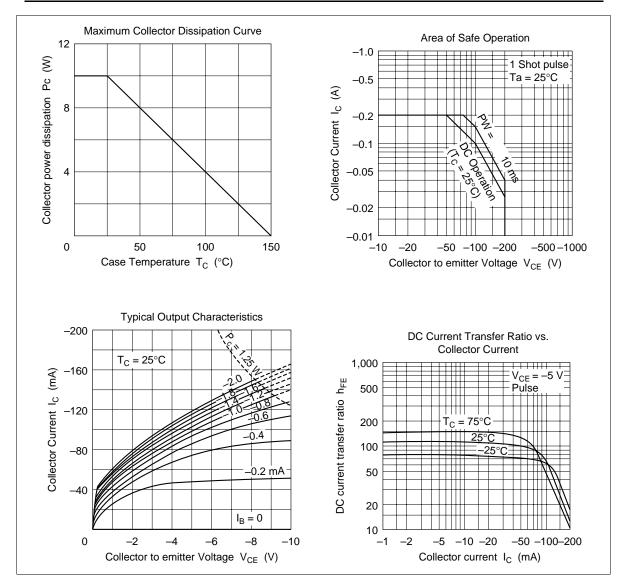
Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	-200	_	_	V	$I_{c} = -10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(\text{BR})\text{CEO}}$	-200	_	_	V	$I_c = -1 \text{ mA}, \text{ R}_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	-5	_	_	V	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{CBO}	_		-10	μΑ	$V_{CB} = -160 \text{ V}, I_{E} = 0$
DC current transfer ratio	h_{FE}^{*1}	60	—	200		$V_{ce} = -5 \text{ V}, \text{ I}_{c} = -10 \text{ mA}$
Base to emitter voltage	V_{BE}	_	—	-1.0	V	$V_{ce} = -5 \text{ V}, \text{ I}_c = -30 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	—	_	-1.0	V	$I_{c} = -30 \text{ mA}, I_{B} = -3 \text{ mA}$
Gain bandwidth product	f _⊤	200	300	_	MHz	$V_{ce} = -20 \text{ V}, I_c = -30 \text{ mA}$
Collector output capacitance	Cob		5.0		pF	$V_{_{CB}} = -30 \text{ V}, \text{ I}_{_{E}} = 0, \text{ f} = 1 \text{ MHz}$

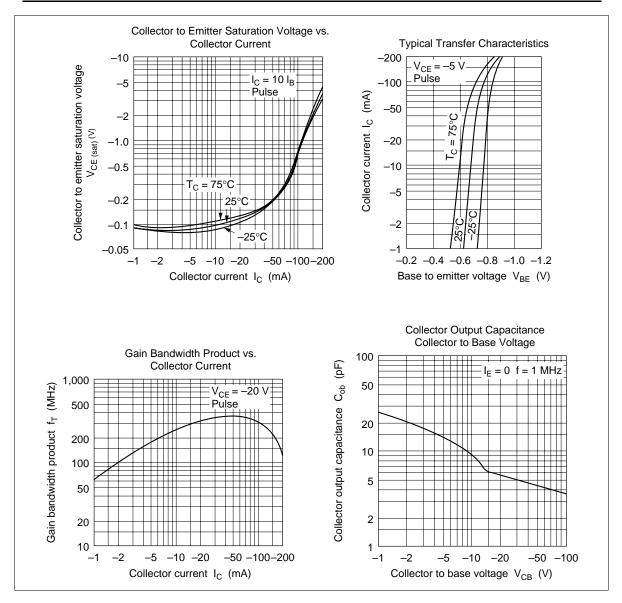
Note: 1. The 2SA1810 is grouped by h_{FE} as follows.

B C 60 to 120 100 to 200

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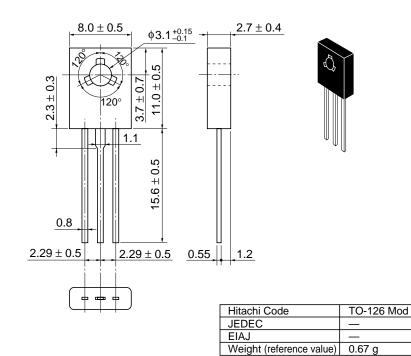


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Unit: mm



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Semiconductor & Integrated Circuits. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109 URL NorthAmerica : http:semiconductor.hitachi.com/

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For further information write to: Hitachi Semiconductor Hitachi Europe GmbH

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose,CA 95134 Tel: <1> (408) 433-1990 Fax: <1>(408) 433-0223

Electronic components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533

Hitachi Asia Ltd. Taipei Branch Office 3F, Hung Kuo Building. No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180 Hitachi Asia (Hong Kong) Ltd. Group III (Electronic Components) 7/F., North Tower, World Finance Centre, Harbour City, Canton Road, Tsim Sha Tsui, Kowloon, Hong Kong Tel: <852> (2) 735 9218 Fax: <852> (2) 730 0281 Telex: 40815 HITEC HX

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